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# MV53164, MV54164, MV57164 Yellow, High Efficiency Green, High Efficiency Red Bargraph Displays

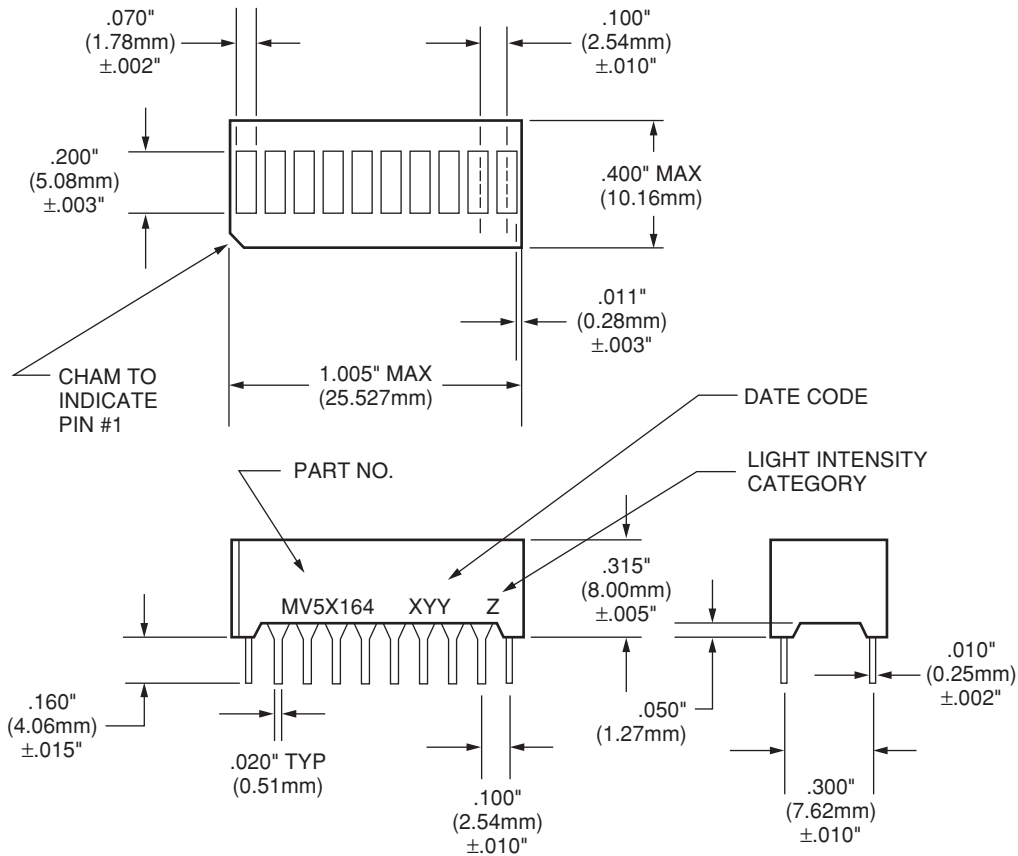
## Features

- Large segment, closely spaced
- End-stackable
- Fast switching—excellent for multiplexing
- Low power consumption
- Directly compatible with IC's
- Wide viewing angle
- Standard .3-inch DIP lead spacing
- Categorized for Luminous Intensity (See Note 1)

## Description

The MV5X164 series is a 10 segment bargraph display with separate anodes and cathodes for each light segment. The packages are end-stackable.

## Package Dimensions



NOTE: Tolerances ±0.10" unless otherwise specified.

MV53164, MV54164, MV57164 Yellow, High Efficiency Green, High Efficiency Red Bargraph Displays

## Absolute Maximum Ratings

Parameter	MV53164	MV54164	MV57164
Power dissipation at 25°C ambient	750 mW	750 mW	750 mW
Derate linearly from 50°C	-14.3 mW/°C	-14.3 mW/°C	-14.3 mW/°C
Storage and operating temperature	-40°C to +85°C	-40°C to +85°C	-40°C to +85°C
Continuous forward current			
Total	200 mA	300 mA	300 mA
Per segment	25 mA	30 mA	30 mA
Reverse voltage			
Per segment	6.0 V	6.0 V	6.0 V
Soldering time at 260°C (See Notes 3 and 5)	5 sec.	5 sec.	5 sec.

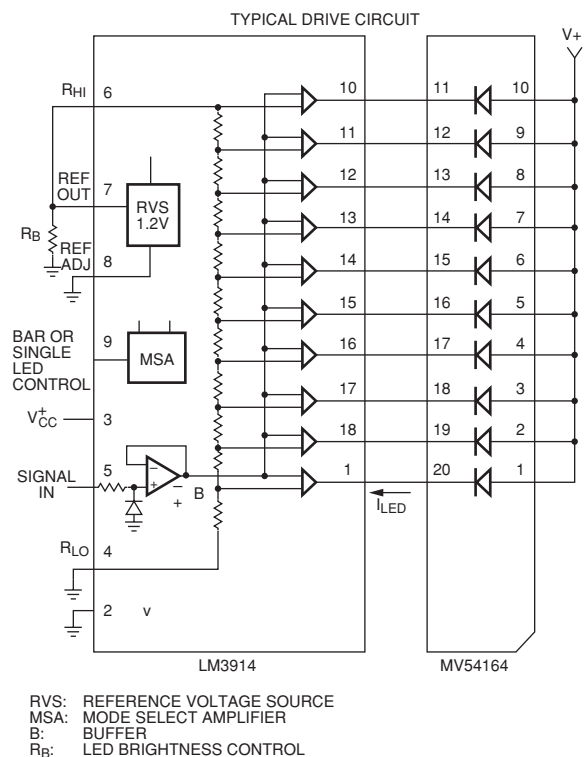
## Typical Thermal Characteristics

Parameter	MV53164	MV54164	MV57164
Thermal resistance junction to free air $\Phi_{JA}$	160°C/W	160°C/W	160°C/W
Wavelength temperature coefficient (case temp.)	1.0 A/°C	1.0 A/°C	1.0 A/°C
Forward voltage temperature coefficient	-1.5 mV/°C	-1.4 mV/°C	-2.0 mV/°C

## Electro-Optical Characteristics (25°C Free Air Temperature Unless Otherwise Specified)

Parameter	Test Conditions	Min.	Typ.	Max.	Units
Forward voltage MV53164, MV57164/MV54164	$I_F = 10$ mA		2.0/2.2	2.5/3.0	V
Luminous Intensity (unit average) (See Note 1)	$I_F = 10$ mA	510	1800		$\mu$ cd
Pulsed Luminous Intensity (MV54164)	$I_F = 60$ mA, peak; 1:6 DF	710	2500		$\mu$ cd
Peak emission wavelength					
MV53164			585		nm
MV54164			562		nm
MV57164			630		nm
Spectral line half width			40/30		nm
MV53164, MV57164/MV54164					
Dynamic resistance Segment	$I_F = 20$ mA		26/12		$\Omega$
MV53164, MV57154/MV54164					
Capacitance MV53164, MV57164/MV54164	$V = 0, f = 1$ MHz		35/40		pF
Switching time	$I_F = 10$ mA		500		ns
Reverse voltage	$I_R = 100$ $\mu$ A	6.0			

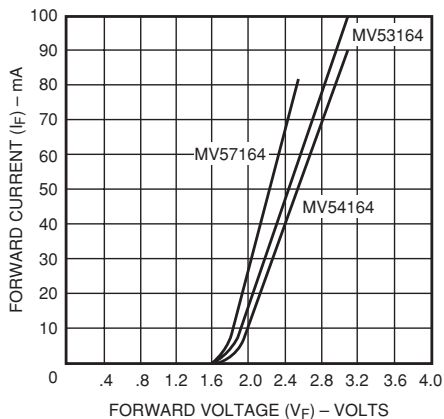
## Typical Drive Circuit



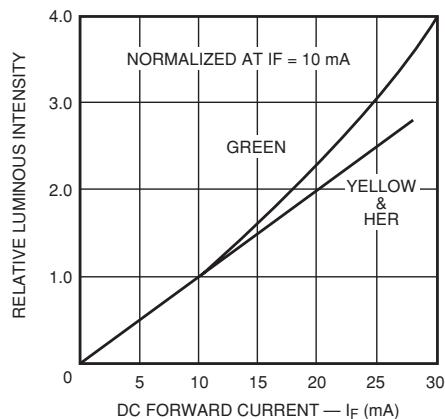
## Pin Connections

Pin No.	Electrical Connections	Pin No.	Electrical Connections	Pin No.	Electrical Connections	Pin No.	Electrical Connections
1	Bar 1 Anode	6	Bar 6 Anode	11	Bar 10 Cathode	16	Bar 5 Cathode
2	Bar 2 Anode	7	Bar 7 Anode	12	Bar 9 Cathode	17	Bar 4 Cathode
3	Bar 3 Anode	8	Bar 8 Anode	13	Bar 8 Cathode	18	Bar 3 Cathode
4	Bar 4 Anode	9	Bar 9 Anode	14	Bar 7 Cathode	19	Bar 2 Cathode
5	Bar 5 Anode	10	Bar 10 Anode	15	Bar 6 Cathode	20	Bar 1 Cathode

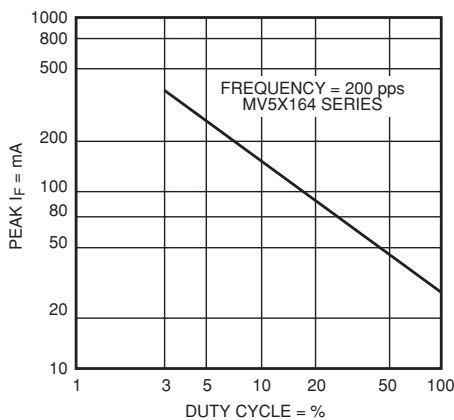
**Typical Curves MV53164, MV54164, MV57164 (Per Segment) (25°C Free Air Temperature)**



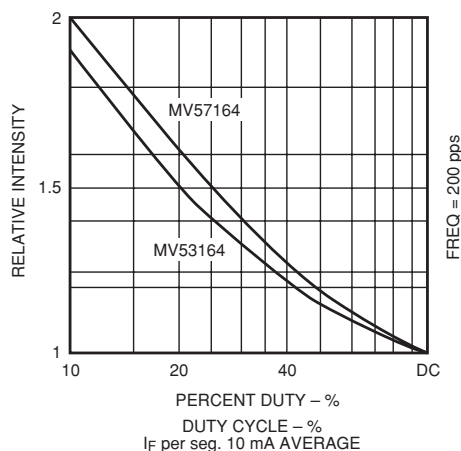
**Fig. 1. Forward Current vs. Forward Voltage**



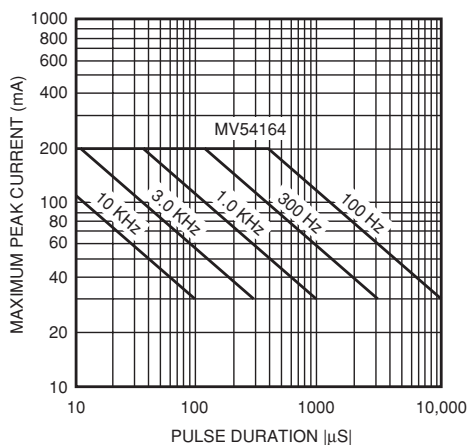
**Fig. 2. Relative Luminous Intensity vs. DC Forward Current (Both LED Chips ON)**



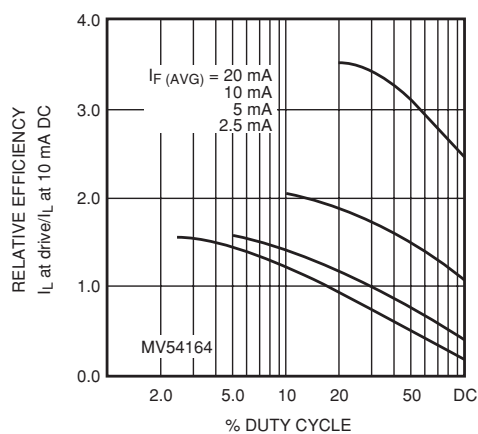
**Fig. 3. Max Peak Current vs. Duty Cycle**



**Fig. 4. Luminous Intensity vs. Duty Cycle**



**Fig. 5. Maximum Peak Current vs. Pulse Duration**



**Fig. 6. Relative Efficiency vs. Duty Cycle**

## Filter Recommendations

For optimum ON and OFF contrast, one of the following filters or equivalents may be used over the lamp:

### MV53164

Panelgraphic Yellow 25 or Amber 23  
Homalite 190—1720 or 100—1726

### MV54164

Panelgraphic Green 48  
Homalite 100—1440 Green

### MV57164

Panelgraphic Red 60  
Homalite 100—1605

In situations of high ambient light, a neutral density filter can be used to achieve greater contrast:

Panelgraphic Grey 10

Panelgraphic Grey 10  
Homalite 100—1266 Grey

## Notes

1. The average Luminous Intensity is obtained by summing the Luminous Intensity of each segment and dividing by the total number of segments. The standard of measurement is the Photo Research Corp. "Spectra" Microcandela Meter (Model IV-D) corrected for wavelength. Intensity will not vary more than  $\pm 33.3\%$  between all segments within a unit.
2. Leads immersed to 1/16 inch (1.6 mm) from the body of the device. Maximum unit surface temperature is 140°C.
3. All units are categorized for Luminous Intensity. The Intensity category is marked on each part as a suffix letter to the part number.
4. For flux removal, Freon TF, Freon TE, isoproponal or water may be used to their boiling points.

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CROSSVOLT™	GlobalOptoisolator™	MicroFET™	PowerTrench®	SuperSOT™-6
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